

Low Density Conductive Foam

BLD

Description

Our low density conductive foam is a polyurethane foam filled with carbon, ensuring excellent ESD protection. Conductive foam is designed for repeat use, and will act like a Faraday cage when an item is fully enclosed within it. Because of this, a static shielding bag is not needed as an outer container when using conductive foam. Low-density component foam is excellent for cushioning static sensitive devices/assemblies; offering great mechanical and electrical protection. This foam can be used in conjunction with a conductive component box to safely store the electronic devices when transporting or handling. Low-density foam meets TS10218 standards meaning it is non-corrosive. In order to avoid damage/crushing, 1 square meter is supplied in 4 pieces, each is 0.5 meter square. Foam can be supplied in any size to suit numerous packaging requirements. Our low-density conductive foam can easily be stamped or shaped to accommodate the most demanding criteria.



Manufactured in the United Kingdom

Key Features

- Colour: Black
- Very low shedding
- Designed for repeat use
- Supplied 1 meter x 1 meter
- Acts like a Faraday cage when an item is fully enclosed within it
- Soft, flexible, non-corrosive polyurethane foam
- Provides good mechanical and electrical protection
- Can be used with a conductive component box
- All foams are made in the United Kingdom
- Bespoke customisation available on request

Standards & Regulations



RoHS compliant



REACH compliant



CE certified



IEC-61340-5-1 compliant

What Is Conductive Foam?

Conductive foam is similar to standard packaging foams but with one crucial difference – the addition of carbon to the polymer mix during the manufacturing process to provide a high level of conductivity. This allows any electric current to pass through the cell structure of the foam and away from the component. Generally, the foam will have permanent conductive performance, meaning it is ideal for multi-trip packaging and in-plant handling applications. Its performance isn't affected by atmospheric conditions.



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The Problem

Static Sensitive Devices (SSD's) are particularly vulnerable to damage from static charged human contact. Personnel handling these devices are generally unaware that walking across a floor, or simply the friction of clothing, can build up massive charges of 1000's of volts which will destroy the chip at a touch. Even protective circuitry does not necessarily protect the device from static charges encountered during routine handling and packaging.

Warning

The answer is to use Electrically Conductive Foam to protect these devices. But, as in medicine, the cure can sometimes be as harmful as the ailment. The materials used in the construction of SSD's, including non-ferrous metals, are highly susceptible to corrosion which can cause irreparable damage during periods of storage. It is therefore, of vital importance that any conductive foam used for handling, packaging and storing of SSD's should be NON-CORROSIVE, and built to the most demanding specifications.

The Solution

A British Company has developed obtained Ministry of Defence, and other approvals, for two grades of non-corrosive electrically conductive foam. Both materials provide maximum protection to SSD's from static discharge and physical damage in storage transportation and operation. VCF conductive foams are treated as safety critical items, and each consignment is manufactured and tested in accordance with the requirements of Defence Standard 05-24.

Corrosion Resistance

Numerous tests in both our own and government accredited laboratories verify compliance with the most demanding specifications. The most corrosion prone non-ferrous metals such as zinc, nickel etc., are not corroded when in direct contact or in vapour contact with conductive foams even at elevated temperatures and humidities.

Compression Set Resistance

The compression set indicates the ability of the foam to retain its original shape and dimensions after being subjected to long term deformation as experienced in packaging of complete PCB's.



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	MOD Specification	Low Density (Typical Values)	High Density (Typical Values)
Volume Resistivity Ωm	250 max.	36.6	56.2
Corrosivity g/m^2			
Vapour	15 max.	5.9	4.9
Contact	15 max.	7.2	6.6
Compression Set % (50% compression)	30 max.	10.5	22.4
Water Extract ph	5.5 min. 8.0 max.	7.8	7.6
Conductivity of Water mS/m	30 max.	18.6	22.6
Water Soluble Chloride %	0.03 max.	0.003	0.003
Total Chlorine %	0.4 max.	0.32	0.34

Part Code	Dimensions
BLD6	1 meter x 1 meter x 6mm
BLD10	1 meter x 1 meter x 10mm
BLD3200	255 x 155 x 10mm (for base or lid)
BLD4300	355 x 255 x 10mm
BLD6400	555 x 355 x 10mm
BLD8600	755 x 555 x 10mm